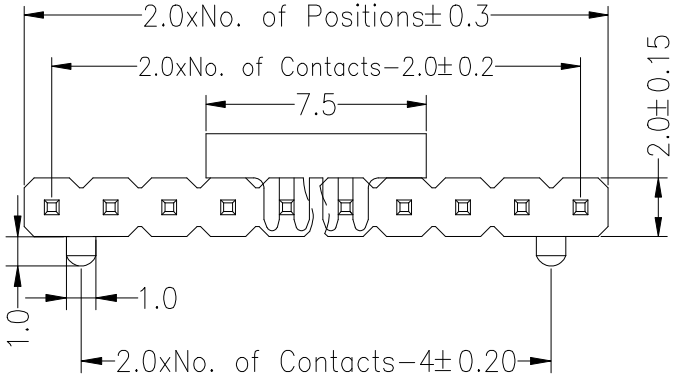
HSF RoHS

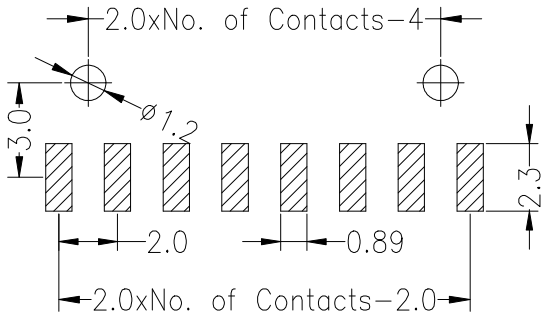
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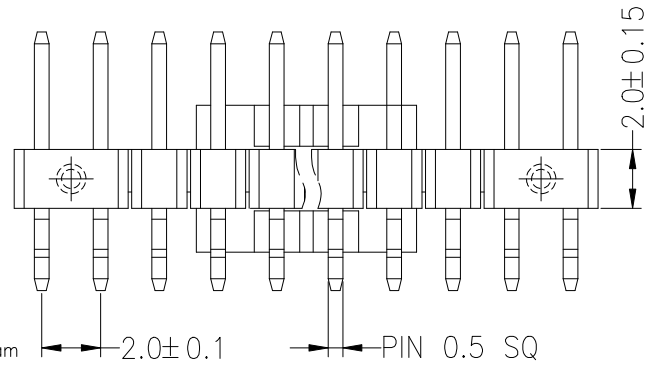
SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

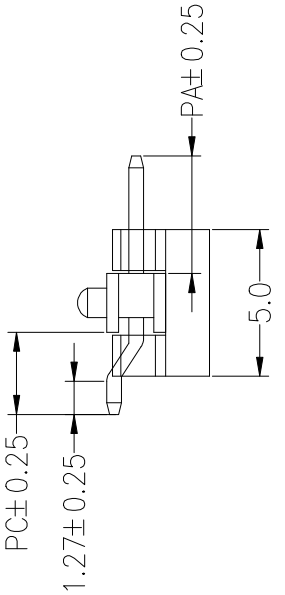
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 5−10 seconds)

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)









Ordering Information

1320 11 XX X W XX Z XXX X 0X

- No.of Pins: 2−40
- Insulator Material Option: C=BK−PA6T; E=BK−PA9T; F=BK−LCP
- Contact Plating: G0:Gold Flash; G1:1U" Gold; G2:1.5U" Gold; G3:2U" Gold; G4:3U" Gold; G5:5U" Gold; S0:Gold Flash/Tin; SN:Tin
- Pin Length
- Packing: 0=PE Bag; A=Tray; T=Tube; P=Tube+Cap; R=Reel+Cap
- code stream: 01~99

Dimension antitheses list		
ITEM	PA	PC
Standard	4.00	2.80

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2019.04.08	NEW DRAWING	

OPERATION		DRAW	Liu Miao	19.04.08	SCALE	FIT
X.X	± 0.30				UNIT	mm
X.XX	± 0.20	CHECK			SIZE	A4
X.XXX	± 0.10				SHEET	1/1
Angle	± 3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	132011XXXWXXZXXXX0X
TITLE:	2.0PH 1xNpin H2.0mm Single 90° SMT